



February 21, 2007

FormFactor to Present at the Goldman Sachs and Morgan Stanley Conferences

LIVERMORE, Calif., Feb 21, 2007 (BUSINESS WIRE) -- FormFactor, Inc. (Nasdaq:FORM) is pleased to announce its participation in the following presentations to the investment communities:

- The Goldman Sachs Technology Investment Symposium, February 28, 2007, at 4:00 PM Mountain Standard Time.
- The Morgan Stanley 2007 Technology Conference on March 7, 2007, at 10:30 AM Pacific Standard Time.

The public is invited to listen to the live webcasts of FormFactor's presentations, which can be accessed from the Investors Section of the Company's website at www.formfactor.com. Replays of the webcasts will also be available approximately two hours following the conclusion of the presentation at www.formfactor.com.

About FormFactor

Founded in 1993, FormFactor, Inc. (Nasdaq:FORM) is the leader in advanced wafer probe cards, which are used by semiconductor manufacturers to electrically test ICs. The company's wafer sort, burn-in and device performance testing products move IC testing upstream from post-packaging to the wafer level, enabling semiconductor manufacturers to lower their overall production costs, improve yields, and bring next-generation devices to market. FormFactor is headquartered in Livermore, California with operations in Europe, Asia and North America. For more information, visit the company's web site at www.formfactor.com.

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SOURCE: FormFactor, Inc.

FormFactor, Inc.

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